

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Atty. Docket: NAKADA=11

In re Application of:	)	Conf. No.: <b>7874</b>
	)	
Tsutomu NAKADA	)	Art Unit: 1795
	)	
Appln. No.: 10/816,168	)	Examiner: Edna Wong
	)	
Filed: April 2, 2004	)	Washington, D.C.
	)	
For: COPPER PLATING BATH AND	)	April 28, 2008
PLATING METHOD	)	

**REPLY: AMENDMENT AND REMARKS**

Honorable Commissioner for Patents  
U.S. Patent and Trademark Office  
Randolph Building, Mail Stop: **Amendment**  
401 Dulany Street  
Alexandria, VA 22314

Sir:

Replying to the Office Action mailed January 28, 2008, please amend as follows:

**Amendments to the Claims** are reflected in the listing of claims that begins on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.